



Product Change Notification

Change Notification #: 116805 - 00
Change Title: Intel® RealSense™ Depth Camera D415,
Intel® RealSense™ Depth Camera D435,
Intel® RealSense™ Depth Camera D435i,
PCN 116805-00, Product Material,
Improved Tripod Quality
Date of Publication: March 08, 2019

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	June 15, 2019
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Description of Change to the Customer:

The Intel® RealSense™ Depth Camera SKUs listed in the products affected table below will have the following change.

The Tripod accessory changed from Plastic Tripod with Plastic feet to Metal Tripod with rubber feet.

The new Tri Pod is made of metal components instead of plastic components which improves the Tri Pod Quality, below pictures highlights the differences between the old and new Tri Pod:

Old

New



Customer Impact of Change and Recommended Action:

No change to the product fit or functionality, changing the Tripod into the new form is a running change.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected / Intel Ordering Codes:

Product Code	MM#	TA
82635ASRCDVKHV	961443	J72476-100
82635AWGDVKPRQ	961448	J72479-100
82635D435IDK5P	999AFR	K38179-100

PCN Revision History:

Date of Revision:

March 8, 2019

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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